BD555BKFV



Datasheet

BD555BKFV AC/DC Controller IC for mains dimmable LED lighting



BD555BKFV

General Description

The BD555BKFV controller AC/DC controller IC can be used in a wide range of dimmable LED lighting driver applications. The main target application is dimmable retro-fit LED lighting, replacing existing incandescent light bulbs, halogen spot lights, CFL tubes etc.

Features

- Fixed frequency DC/DC controller (selectable)
- Peak current or average current control (PCC/ACC)
- Dynamic Load Current Controller (DLCC)
- Logarithmic compensation of detected dimming level
- Dimmer detector function
- Anti-flash function when dimmer is OFF
- PWM and analog dimming control supported
- Over Current Protection (OCP)
- Thermal Shutdown protection (TSD)
- Under Voltage Lock Out (UVLO)

Applications

- Retro-fit dimmable LED lighting (E27, E14, GU10, T8 etc.). Wide range of TRIAC and transistor dimmers supported by DLCC function.
- Custom LED lighting with PWM or voltage controlled dimming.

•Key Specifications

- Input voltage range......16~39V
- Regulated supply voltage.....11.5V
- Fixed DC/DC operating frequency.......40~400kHz
- Detectable phase-cut range......45°~135°
- Typical current consumption.....1mA
- Operating temperature range.....-40~+110℃

Package SSOP-B14 W(Typ.) x D(Typ.) x H(Max.) 5.00mm x 6.40mm x 1.15mm





Figure 1. Typical application circuit for non-isolated dimmable buck topology

Typical Application Circuits

Pin Configuration



Figure 2. Pin configuration

Figure 3. Equivalent circuit

Pin Description

Pin	Pin name	Function					
1	BLDR	Driver for dynamic load current controller (DLCC) transistor					
2	WBLD	_D Internal strong load current input (connected to internal 'open drain' NMOS)					
3	ISYS ^{*1}	YS ^{*1} Sense voltage input for DLCC ON/OFF function					
4	GND	ND Ground terminal					
5	DIM Detected dimming level reference voltage						
6	DET Input for detecting phase-cut angle						
7	REF ^{*2}	EF ^{*2} Pin for external resistor to set LED current (average current control mode)					
8	OSC ^{*2}	OSC ^{*2} Pin for external resistor to set DC/DC operating frequency					
9	FB^{*3} Average current feedback input or PCC mode selection (V _{FB} <1.5V)						
10	ISNS	Sense voltage for peak current regulation & over current protection (OCP)					
11	PGND ^{*4}	Ground terminal for internal BLDR and SW driver stages					
12	SW	Driver output for gate of external DC/DC switching MOSFET					
13	VDDH	Regulated supply voltage					
14	SUP	Input supply voltage					

*1 Between ISYS and GND are internal anti-parallel surge diodes

*2 Connect only resistive load according to application instructions

*3 FB terminal is 'pre-charged' to 4V during start-up in order to have smooth start of the LED current regulation. Never connect this pin directly to GND.

*4 Between GND and PGND are internal anti-parallel diodes

Block Diagram



Figure 4. Block diagram of BD555BKFV functions

Description of Blocks

<u>Startup sequence</u>: when an AC input voltage is applied, the rectified mains voltage (VHV) is buffered by capacitor C2 and starts supplying the BD555BKFV via start-up resistor R6. The VDDH capacitor C5 will be charged by the internal regulator until the system UVLO condition is released, after which a PWM signal from terminal SW can start driving the external NMOS when the anti-flash detector is released.

<u>Anti-flash detector</u>: Some dimmers require a small leakage current to power an internal electronic control circuit or an indicator LED. In order to prevent a 'false start' when the VHV buffer cap was accidentally charged by this leakage current, the detection level voltage on the DIM terminal needs to rise above 400mV, before the SW terminal starts switching, lighting up the LEDs.

DC/DC buck converter: when the SW signal is high, it turns ON the MN2 MOSFET, building up a current in coil L1 via the LED string. During the OFF period of MN2, the current flows via fly-back diode D4. Capacitor C4 stabilizes the LED voltage to reduce the LED current ripple. The LED current is regulated by controlling the LED forward voltage.

<u>Auxiliary supply voltage</u>: The alternating current in the primary side of inductor L1 is coupled $n_p:n_s$ to the secondary side, creating a voltage alternating between V_{VHV} (MN2=ON) and $(V_{LED} + V_{th,D4})^* n_s/n_p$ (MN2=OFF). This last voltage is passed on to capacitor C3 via diode D5. This creates an auxiliary supply which improves efficiency by reducing the resistive power loss in the start-up resistor R6.

LED average current control (ACC) mode: The BD555BKFV features two feedback mechanisms by average current control (ACC) or peak current control (PCC). In ACC mode, the high-side sensing resistor R7 is used in the LED current mirror (typically 1:500), creating an LED feedback current in transistor Q1. This current flows to the FB terminal and creating a reference voltage (for LED current regulation) across resistor R12 at the REF terminal.

LED peak current control (PCC) mode: Alternatively, in PCC mode (V_{FB} <1.5V), the duty-cycle of the SW signal is determined by the 'peak current' through resistor R10. The ISNS terminal senses the voltage across resistor R10. When this voltage reaches the reference voltage, the SW signal will be pulled low. During startup and in ACC mode, this function is used as 'Over Current Protection' to limit the current through inductor L1. In both ACC and PCC mode, the REF voltage will be adjusted to the detected phase-cut in case a dimmer is connected.

<u>Phase-cut detection:</u> via resistive divider R4/R5 at the DET terminal, the rising and falling edge of the phase-cut are detected, generating an internal PWM signal. Via an internal resistor and external capacitor C1, this PWM signal is averaged into a dimming reference voltage at the DIM terminal. An internal conversion function creates a logarithmically corrected voltage at the REF terminal. This allows achieving a 'natural' LED light intensity curve as perceived by the human eye, when turning the dimmer knob.

Dimmer stability: based on the phase-cut detection at the DET terminal, the DLCC dynamically adjusts the total load current for stable operation of 'leading edge' TRIAC dimmers. For 'trailing edge' dimmers, the DLCC load current pulls down the dimmer output voltage, in order to detect the falling edge. In case the VHV current exceeds the minimum load current requirement, the DLCC load current can disabled completely. This allows to achieve high efficiency without dimmers.

Dimmer detector: when a dimmer is not present, the DLCC will be switched OFF.

Absolute Maximum Ratings

Parameter	Symbol	Maximum rating	Unit
Supply voltage (SUP terminal)	V _{SUP}	40	V
Internal supply regulator voltage (VDDH terminal)	V _{VDDH}	15.5	V
SW output current	I _{SW}	600 ^{*1}	mA
BLDR output current	I _{BLDR}	60 ^{*1}	mA
WLBD, ISNS terminal voltage	V _{WBLD} , V _{ISNS}	15.5	V
WBLD input current (strong load current)	I _{SBLD}	300 ^{*2}	mA
DIM, DET, OSC, REF, FB terminal voltage	$V_{DIM},V_{DET},V_{OSC},V_{REF},V_{FB}$	4.5	V
FB input current (V _{FB} =4.5V)	I _{FB}	4.0	mA
ISYS, PGND terminal voltage	V _{ISYS} , V _{PGND}	+/- 0.5	V
Operating frequency	f _{operating}	400	kHz
Maximum power dissipation	P _d	0.87 ^{*4}	W
Operating ambient temperature range	T _a	-40 ~ +110	C
Storage temperature range	T _{storage}	-55 ~ +150	C
Maximum junction temperature	T _{junction,max}	+150	C

*1 I_{SW} pulse current duration <100ns@ f_{operating}
*2 I_{BLDR} pulse current duration <1us@ f_{mains}
*3 I_{WBLD} pulse current duration <300us@ f_{mains}
*4 SSOP-B14 package thermal resistance R_{BJA}=143 °C/W, mounted on a two-layer PCB of 70x70x1.6mm³

●Recommended Operating Range (Ta= -40 ~ +110℃)

Parameter	Symbol	Range	Unit
Supply voltage	VSUP	16 ~ 39	V

Electrical Characteristics

Deremeter	Symbol	Limits			l loit	Commente		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Comments		
Internal Supply Regulator* ¹	nternal Supply Regulator* ¹							
Startup current	I _{SUP,start}	-	0.4	0.8	mA	In UVLO condition		
Supply current ON	I _{SUP,NS}	-	0.8	1.0	mA	No switching.		
Supply current ON 1	I _{SUP,ON1}	-	1.0	1.3	mA	No load on SW/BLDR, $f_{SW} = 40$ KHz.		
Supply current ON 2	I _{SUP,ON2}	-	2	2.4	mA	No load on SW/BLDR, f_{SW} =400KHz.		
VDDH internal regulator voltage	V _{VDDH}	10.0	11.5	15.0	V	VDDH load current I _{VDDH} < 10mA		
UVLO release voltage	V _{UVLO,rl}	9.20	10.0	10.8	V	VDDH rising		
UVLO trigger voltage	V _{UVLO,tr}	V _{UVLO,tr} - V _{UVLO,hys}		V	VDDH falling			
UVLO hysteresis	V _{UVLO,hys}	0.75	1.00	1.25	V			
Switching regulator	Switching regulator							
Minimum frequency	f _{SW_min}	32	40	48	kHz	$f_{\rm SW} = 9.0 \times 10^6 / \text{R11} (\text{kHz})^{\pm 20\%},$		
Maximum frequency	f _{SW_max}	320	400	480	kHz	for frequency range 40KHz to 400KHz.		
SW maximum duty cycle	δ_{max}	70	75	80	%			
SW minimum ON-time	t _{ON,min}	-	80	140	ns	Determines minimum duty-cycle		

Deremeter	Symbol	Limits			Llpit	Commonto	
Farameter		Min.	Тур.	Max.	Unit	Comments	
SW slew rate	t _{SW,slew}	-	50	100	ns	V_{SW} = 111V at 1nF load (rising/falling)	
SW driver ON resistance (PMOS)	$R_{SW,P}$	-	15	40	Ω	V _{SW} =0V, I _{SW} =-10mA	
SW driver OFF resistance (NMOS)	R _{SW,N}	-	15	40	Ω	V _{SW} = VDDH, I _{SW} =10mA	
Duty cycle, FB=3.5V	δ ₂₀	2	20	38	%	ACC mode	
Duty cycle, FB=2.9V	δ ₆₀	36	60	80	%	ACCINOLE	
FB mode selection threshold	V _{FB,mode}	1.4	1.6	1.9	V	PCC (V _{FB} <1.4V), ACC (V _{FB} >1.9V)	
ISNS trigger voltage (OCP)	V _{OCP}	1.08	1.20	1.36	V	Inductor current limiter in ACC mode	
ISNS blanking time (OCP)	t _{OCP,blank}	90	140	180	ns	Used in PCC & ACC mode	
Dimmer phase-cut detector						·	
DET phase cut voltage (rising)	V _{DET,r}	215	260	300	mV		
DET phase cut voltage (falling)	V _{DET,f}	75	110	190	mV	Nionitored at output bridge rectifier	
DET phase cut hysteresis	V _{DET,hys}	75	130	180	mV		
DIM voltage (no dimming)	V _{DIM1}	2.85	3.0	3.15	V	Phase-cut = 135°	
DIM voltage (max dimming)	V _{DIM2}	0.95	1.0	1.05	V	Phase-cut = 45°	
REF voltage (no dimming) ACC	V _{REF,A1}	1.85	2.0	2.15	V	ACC mode (VER>1.9).	
REF voltage (max dimming) ACC	V _{REF,A2}	75	100	135	mV	$2k\Omega < R_{REF} < 10k\Omega$	
ISNS voltage (no dimming) PCC	VISNS,P1	1.12	1.24	1.36	V	PCC mode (VFB < 1.5V). VISNS peak	
ISNS voltage (max dimming) PCC	V _{ISNS,P2}	200	260	316	mV	current threshold, $R_{REF}=2k\Omega$	
Dynamic Load Current Controller		1				1	
BLDR driver slew rate	t _{BLDR,slew}	-	1	5	μs	V _{SW} = 111V at 1nF load (rising/falling)	
BLDR driver ON resistance	R _{BLDR,P}	-	100	300	Ω	V _{BLDR} =0V, I _{BLDR} =-10mA	
BLDR driver OFF resistance	R _{BLDR,N}	-	100	300	Ω	V _{BLDR} = VDDH, I _{BLDR} =10mA	
Strong load current	I _{SBLD,sat}	200	250	-	mA	Strong load current ON (V _{ISYS} <100mV, V _{DIM} <3.4V, V _{VDDH} =11.5V, V _{WBLD} .V _{ISYS} =8V)	
Strong load internal NMOS RON	R _{ON,SBLD}	-	10	300	Ω	Strong load current ON (V _{ISYS} <100mV, V _{DIM} <3.4V, V _{VDDH} =11.5V, V _{WBLD} -V _{ISYS} =8V)	
Strong load current OFF delay	t _{SB,OFF}	180	250	320	μs	After phase-cut rising edge	
Dimmer detector trigger voltage	V _{DIM,tr}	3.3	3.5	3.7	V	DLCC load current OFF	
Dimmer detector release voltage	V _{DIM,rl}	VD	MM,tr-VDIN	1,hys	V	DLCC load current ON	
Dimmer detector hysteresis	V _{DIM,hys}	50	100	170	mV		
ISYS load current OFF voltage	V _{ISYS,OFF}	-260	-200	-160	mV	DLCC load current OFF	
ISYS load current ON voltage	V _{ISYS,ON}	VISYS,OFF+VISYS,hvs		mV	DLCC load current ON		
ISYS current sense hysteresis	V _{ISYS,hys}	75	100	140	mV		
Anti-flash detector threshold	V _{DIM,start}	360	400	440	mV	DC/DC starts switching (V _{DIM} >400mV)	

*1 The supply regulator has a thermal shutdown function that triggers at about 175°C, having a hystere sis of about 20°C. This protects against a too high junction-temperature (e.g. due to 'short' currents of VDDH, SW or BLDR to (P)GND on the PCB or excessive ambient temperatures).

Application Examples

The BD555BKFV is typically used as a controller IC in retro-fit dimmable LED lighting systems. The external component selection is fully dependent on the type of LED driver. For more information about this, please refer to the BD555BKFV application note. The example circuit below shows a dimmable non-isolated buck converter. A non-isolated topology is suitable for relatively low LED power (e.g. V_{LED} =100V and I_{LED} =40mA) applications in which the LED heatsink is electrically isolated by a non-conductive LED lamp casing.



Figure 5. Final application circuit for non-isolated dimmable ACC LED driver

Notes of board layout

There are a few considerations for designing a small-sized PCB that fits inside a LED lamp casing. Special attention needs to be given to component placement for optimal grounding and minimum distances of high-voltage wiring.

- 1) OCP sense resistor R_{OCP} and snubber resistor Rs need to be connected as close as possible to the minus terminal of the VHV buffer capacitor.
- 2) The drain terminal of switching NMOS MN2 should be close to the inductor L1p and fly-back diode D4.
- 3) The GND and PGND terminals need to be connected directly on the PCB.
- 4) For mains-isolated designs (not described in this document), the isolated PCB terminals need to be separated from the 'hot' side electronics.

Selection of Components Externally Connected

Please refer to the BD555BKFV application note for more information about selecting the external components.

• Power Dissipation

The power dissipation of the BD555BKFV is mainly dependent on the fixed DC/DC operating frequency and the applied load at the SW and BLDR terminals. This power consumption should be less than 80% of the allowable package power dissipation.

Operational Notes

1) Absolute Maximum Ratings

When the IC is operated outside of the given absolute maximum ratings, internal devices of the IC can break down and resulting failure modes may be impossible to identify. In case any special operating mode exceeding the absolute maximum ratings is assumed, consideration should be given to take physical safety measures including the use of fuses or overvoltage clamping devices, etc.

- 2) Special Caution on Terminal Connections
 - a. Never connect the FB terminal directly to GND. To enable PCC mode, the FB terminal is best pulled down by a resistor (>10k) to GND.
 - b. Always protect the ISYS terminal with a reverse diode to GND in case of using ground current sensing in a dimmable LED driver application. For additional operation stability, a capacitor >1uF is added between GND and ISYS terminals.
 - c. Never connect a capacitive load to the REF and OSC terminals. Only resistive loads can be connected to these terminals.
 - d. Always short GND and PGND terminals on the application PCB. Special care needs to be taken to keep the GND terminal free from noise. None of the IC terminals except ISYS should have a negative potential.
 - e. No external voltage should be applied to the IC terminals when the supply voltage on the SUP terminal is absent.
- 3) Erroneous Mounting and Terminal Short Circuit If the IC is mounted incorrectly or in case of a short circuit between supply line, ground and other terminals, the IC may malfunction or break down.
- 4) Thermal Shut Down

When the IC junction temperature exceeds about 175°C, the TSD function disables internal circuits of the IC and pulls down the internal supply voltage VDDH. The SW terminal will cease switching which stops the DC/DC operation of the application. This safety measure also reduces potential physical damage as a result of overheating in case of a short circuit between VDDH, SW, BLDR and GND terminals. In the thermal design of the application (PCB), the maximum ambient operating temperature and SSOP-B14 maximum power dissipation (Pd) need to be considered to avoid unwanted triggering of the TSD function.

- 5) Operation in Electromagnetic Fields The functionality of this IC is not guaranteed in the presence of (strong) electromagnetic fields.
- 6) External Buffer Capacitors

The capacitor value derating of vs. voltage and temperature and lifetime degradation need to be taken into account in order to ensure proper operation of the IC.

Status of this document

The English version of this document is formal specification. Versions in other languages are for reference only. In case of a difference between this English document and a translated version, this formal English version takes priority.

Ordering Information



Physical Dimension Tape and Reel Information

SSOP-B14



Marking Diagram (TOP VIEW)



Revision History

Date	Revision	Changes
03.Aug.2012	001	New Release

Notice

General Precaution

- Before you use our Products, you are requested to carefully read this document and fully understand its contents. ROHM shall not be in any way responsible or liable for failure, malfunction or accident arising from the use of any ROHM's Products against warning, caution or note contained in this document.
- All information contained in this document is current as of the issuing date and subject to change without any prior notice. Before purchasing or using ROHM's Products, please confirm the latest information with a ROHM sales representative.

Precaution on using ROHM Products

- 1) Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment, transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.
- 2) ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
 - [a] Installation of protection circuits or other protective devices to improve system safety
 - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
- 3) Our Products are designed and manufactured for use under standard conditions and not under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
 - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4) The Products are not subject to radiation-proof design.
- 5) Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6) In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse) is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7) De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8) Confirm that operation temperature is within the specified range described in the product specification.
- 9) ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1) When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2) In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2) You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1) Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3) Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4) Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

QR code printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

Precaution for Foreign Exchange and Foreign Trade act

Since our Products might fall under controlled goods prescribed by the applicable foreign exchange and foreign trade act, please consult with ROHM representative in case of export.

Precaution Regarding Intellectual Property Rights

- 1) All information and data including but not limited to application example contained in this document is for reference only. ROHM does not warrant that foregoing information or data will not infringe any intellectual property rights or any other rights of any third party regarding such information or data. ROHM shall not be in any way responsible or liable for infringement of any intellectual property rights or other damages arising from use of such information or data.:
- 2) No license, expressly or implied, is granted hereby under any intellectual property rights or other rights of ROHM or any third parties with respect to the information contained in this document.

Other Precaution

- The information contained in this document is provided on an "as is" basis and ROHM does not warrant that all information contained in this document is accurate and/or error-free. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties resulting from inaccuracy or errors of or concerning such information.
- 2) This document may not be reprinted or reproduced, in whole or in part, without prior written consent of ROHM.
- 3) The Products may not be disassembled, converted, modified, reproduced or otherwise changed without prior written consent of ROHM.
- 4) In no event shall you use in any way whatsoever the Products and the related technical information contained in the Products or this document for any military purposes, including but not limited to, the development of mass-destruction weapons.
- 5) The proper names of companies or products described in this document are trademarks or registered trademarks of ROHM, its affiliated companies or third parties.





Мы молодая и активно развивающаяся компания в области поставок электронных компонентов. Мы поставляем электронные компоненты отечественного и импортного производства напрямую от производителей и с крупнейших складов мира.

Благодаря сотрудничеству с мировыми поставщиками мы осуществляем комплексные и плановые поставки широчайшего спектра электронных компонентов.

Собственная эффективная логистика и склад в обеспечивает надежную поставку продукции в точно указанные сроки по всей России.

Мы осуществляем техническую поддержку нашим клиентам и предпродажную проверку качества продукции. На все поставляемые продукты мы предоставляем гарантию.

Осуществляем поставки продукции под контролем ВП МО РФ на предприятия военно-промышленного комплекса России, а также работаем в рамках 275 ФЗ с открытием отдельных счетов в уполномоченном банке. Система менеджмента качества компании соответствует требованиям ГОСТ ISO 9001.

Минимальные сроки поставки, гибкие цены, неограниченный ассортимент и индивидуальный подход к клиентам являются основой для выстраивания долгосрочного и эффективного сотрудничества с предприятиями радиоэлектронной промышленности, предприятиями ВПК и научноисследовательскими институтами России.

С нами вы становитесь еще успешнее!

Наши контакты:

Телефон: +7 812 627 14 35

Электронная почта: sales@st-electron.ru

Адрес: 198099, Санкт-Петербург, Промышленная ул, дом № 19, литера Н, помещение 100-Н Офис 331